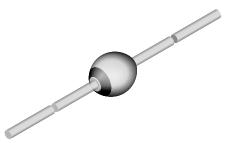


# BYT54A, BYT54B, BYT54D, BYT54G, BYT54J, BYT54K, BYT54M

Vishay Semiconductors

# **Fast Avalanche Sinterglass Diode**



949539

#### **FEATURES**

- · Glass passivated junction
- · Hermetically sealed package
- · Low reverse current
- · Soft recovery characteristics
- Material categorization:
  For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>





COMPLIANT HALOGEN

### **MECHANICAL DATA**

Case: SOD-57

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

**Mounting position:** any **Weight:** approx. 369 mg

#### **APPLICATIONS**

Very fast rectification and switching diodes

ORDERING INFORMATION (Example)					
DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY		
BYT54M	BYT54M-TR	5000 per 10" tape and reel	25 000		
BYT54M	BYT54M-TAP	5000 per ammopack	25 000		

PARTS TABLE					
PART	TYPE DIFFERENTIATION	PACKAGE			
BYT54A	$V_R = 50 \text{ V}; I_{F(AV)} = 1.25 \text{ A}$	SOD-57			
BYT54B	V <sub>R</sub> = 100 V; I <sub>F(AV)</sub> = 1.25 A	SOD-57			
BYT54D	V <sub>R</sub> = 200 V; I <sub>F(AV)</sub> = 1.25 A	SOD-57			
BYT54G	$V_R = 400 \text{ V}; I_{F(AV)} = 1.25 \text{ A}$	SOD-57			
BYT54J	V <sub>R</sub> = 600 V; I <sub>F(AV)</sub> = 1.25 A	SOD-57			
BYT54K	V <sub>R</sub> = 800 V; I <sub>F(AV)</sub> = 1.25 A	SOD-57			
BYT54M	$V_R = 1000 \text{ V}; I_{F(AV)} = 1.25 \text{ A}$	SOD-57			

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT		
	See electrical characteristics	BYT54A	$V_R = V_{RRM}$	50	V		
		BYT54B	$V_R = V_{RRM}$	100	V		
Decrees well-server at the control of the control o		BYT54D	$V_R = V_{RRM}$	200	V		
Reverse voltage = repetitive peak reverse voltage		BYT54G	$V_R = V_{RRM}$	400	<b>V</b>		
Voltago		BYT54J	$V_R = V_{RRM}$	600	V		
		BYT54K	$V_R = V_{RRM}$	800	V		
		BYT54M	$V_R = V_{RRM}$	1000	V		
Peak forward surge current	$t_p = 10 \text{ ms}$ , half sine wave		I <sub>FSM</sub>	30	Α		
Average forward current	On PC board		I <sub>F(AV)</sub>	0.75	Α		
Average forward current	I = 10 mm		I <sub>F(AV)</sub>	1.25	Α		
		BYT54J	E <sub>R</sub>	10	mJ		
Non repetitive reverse avalanche energy	$I_{(BR)R} = 0.4 A$	BYT54K	E <sub>R</sub>	10	mJ		
		BYT54M	E <sub>R</sub>	10	mJ		
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C		

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MAXIMUM THERMAL RESISTANCE (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER TEST CONDITION		SYMBOL VALUE		UNIT	
Junction ambient	Lead length I = 10 mm, T <sub>L</sub> = constant	$R_{thJA}$	45	K/W	
	On PC board with spacing 25 mm	R <sub>thJA</sub>	100	K/W	

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBO L	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 1 A		$V_{F}$	-	-	1.5	V
Reverse current	$V_R = V_{RRM}$		I <sub>R</sub>	-	-	5	μΑ
	$V_R = V_{RRM}$ , $T_j = 150$ °C		I <sub>R</sub>	-	-	150	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_R = 0.25 \text{ A}$		t <sub>rr</sub>	-	-	100	ns

#### **TYPICAL CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

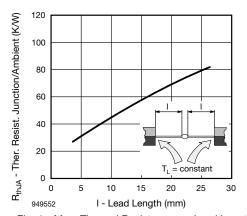


Fig. 1 - Max. Thermal Resistance vs. Lead Length

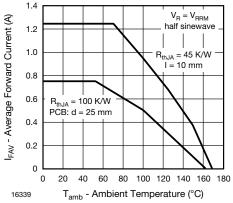


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

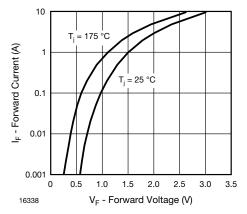


Fig. 2 - Forward Current vs. Forward Voltage

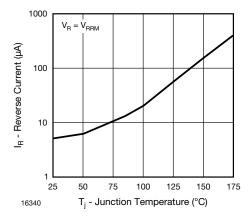
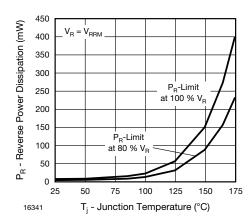


Fig. 4 - Max. Reverse Current vs. Junction Temperature

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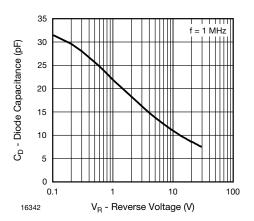
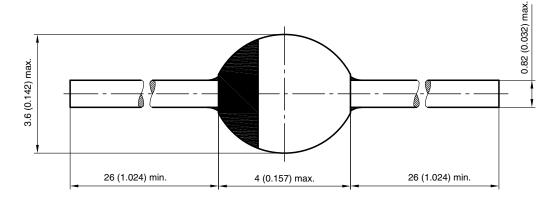


Fig. 6 - Diode Capacitance vs. Reverse Voltage

#### PACKAGE DIMENSIONS in millimeters (inches): SOD-57



20543

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